PATENT APPLICATION TRANSMITTAL LETTER

(Large Entity)

Docket No.

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of:

TERRENCE P. MEIER ET AL.

For: TWO MATERIAL OVER-MOLDED FITMENT

Enclosed	l are
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- ☑ Certificate of Mailing with Express Mail Mailing Label No. ET485282739US
- Informal sheets of drawings.
- ☐ A certified copy of a application.
- Declaration
 Signed.
 Unsigned
- ☑ Power of Attorney
- M Information Disclosure Statement
- Preliminary Amendment
- 🗷 Other: Assignment \$40 fee incl., 14 pages of specification incl. claims, abstract and postcard.

CLAIMS AS FILED

For	#Filed	#Allowed	#Extra		Rate		Fee		
Total Claims	27	- 20 =	7	x	\$18.00		\$126.00		
Indep. Claims	3	- 3 =	0	х	\$84.00		\$0.00		
Multiple Dependen	t Claims (check	if applicable)					\$0.00		
					В	ASIC FEE	\$750.00		
					TOTAL FI	LING FEE	\$876.00		

- 🗷 A check in the amount of \$916,00 to cover the filling fee is enclosed.
- The Director is hereby authorized to charge and credit Deposit Account

09-0025

- as described below.

 Charge the amount of
- as filing fee.
- Credit any overpayment.
- M Charge any additional filling fees required under 37 C.F.R. 1.16 and 1.17.
- Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance,

pursuant to 37 C.F.R. 1.311(b).

Dated: JULY 15, 2003

Yaul F. Do

PAUL F. DONOVAN ATTORNEY OF RECORD REG. NO. 39,962

cc: